EAST Search History

Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	17070	((light emitting diode) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:26
32	1061480	((light emitting diode) or "LED")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:26
 64	385	semiconductor light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:27
	22	(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:28
66	1061572	S1 or S2 or S4 or S5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:28
\$7	595921	(circuit board) or ((printed circuit board) or "PCB")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:29

S8	559851		US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:31
 39	23162		US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:31
310	1449		US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:33
S11	137		US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:35
S12	63		US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:36
S13	5	(US-6893258-\$ or US-6743249-\$ or US-6595671-\$).did. or (JP-08202290-\$ or JP-06095064-\$).did.	USPAT; JPO	NEAR	ON	2009/05/13 21:46
314	74	-35	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:46
S15	8	(US-20090099499-\$ or US-20090032825-\$ or US-20070030662-\$).did. or (US-20090032825-\$ or CN-200972986-\$ or KR-2007102320-\$ or CN-2934891-\$ or KR-2005100083-\$).did.	US-PGPUB; DERWENT	NEAR	ON	2009/05/13 21:57

S16	13	S13 or S15	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO;	NEAR	ON	2009/05/13 21:57
 S17	317	S10 and "362"/\$.ccls.	DERWENT; BM_TDB US-PGPUB;	NEAR	ON	2009/05/13
	011	Ο ΤΟ απά 302 /ψ.colb.	USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NLAIT	ON	21:59
518	243	S10 and "257"/\$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:59
319	8	S10 and "600"/\$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 22:02
20	3	S10 and "604"/\$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 22:02
521	8	S10 and "607"/\$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 22:02
S22	527	S17 or S18 or S19 or S20 or S21	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 22:03

S23	183	S22 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 22:03
S24	156	S23 not S11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 22:03
S25	6	(US-20020143373-\$).did. or (US-6874901-\$ or US-6059414-\$ or US-5771617-\$ or US-5475241-\$ or US-4865038-\$).did.	US-PGPUB; USPAT	NEAR	ON	2009/05/13 22:10
S26	19	\$16 or \$25	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 22:11
S27	17104	((light emitting diode) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S28	1062236	((light emitting diode) or "LED")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S29	385	semiconductor light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41

S30	22	(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S31	1062328	S27 or S28 or S29 or S30	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S32	596344	(circuit board) or ((printed circuit board) or "PCB")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S33	560258	circuit with S32	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S34	23197	S33 with S31	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S35	1684	S34 with (capsulat\$4 or capsulant or encased or embed\$4 or laminat\$4 or layer\$4 or encapsulat\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S36	173	S34 with (transparent or clear or (ligh transmit\$5) or refract\$4) with (capsulat\$4 or capsulant or encased or embed\$4 or laminat\$4 or layer\$4 or encapsulat\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:43

S37	79	S36 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:44
S38	7	(US-20050009242-\$).did. or (US-6893258-\$ or US-6743249-\$ or US-6595671-\$). did. or (JP-08202290-\$ or JP-06095064-\$).did. or (WO-9724770-\$).did.	US-PGPUB; USPAT; JPO; DERWENT	NEAR	ON	2009/05/14 09:54
S39	5	(US-6893258-\$ or US-6743249-\$ or US-6595671-\$).did. or (JP-08202290-\$ or JP-06095064-\$).did.	USPAT; JPO	NEAR	ON	2009/05/14 09:55
S40	8	(US-20090099499-\$ or US-20090032825-\$ or US-20070030662-\$).did. or (US-20090032825-\$ or CN-2934891-\$ or KR-2005100083-\$).did.	US-PGPUB; DERWENT	NEAR	ON	2009/05/14 09:55
S41	13	S39 or S40	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:55
S42	6	(US-20020143373-\$).did. or (US-6874901-\$ or US-6059414-\$ or US-5771617-\$ or US-5475241-\$ or US-4865038-\$).did.	US-PGPUB; USPAT	NEAR	ON	2009/05/14 09:55
S43	19	S41 or S42	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:55
S44	21	S38 or S43	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:55
S45	17185	((light emitting diode) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30

S46	1063520	((light emitting diode) or "LED")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S47	386	semiconductor light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S48	22	(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S49	1063613	S45 or S46 or S47 or S48	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S50	597412	(circuit board) or ((printed circuit board) or "PCB")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S51	26058	S50 with S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S52	1712	S50 and (S49 with (laminat\$4 or embed\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:32

\$53	1083	S50 and (S49 with (laminat\$4 or embed\$3)) and (transparent or clear or (ligh transmit\$5) or refract\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:34
S54	178	S50 and ((S49 with (laminat\$4 or embed\$3)) with (transparent or clear or (ligh transmit\$5) or refract\$4))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:35
S55	83	S54 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:42
S56	9709	362/153,320,330,471,479,488,490,492,1606,607,608,611-613,617,619,619,621,630,631,632,543-546,800,806.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:15
S57	5207	S56 and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:16
S58	78	S56 and S53	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:17
S59	38	S58 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:18

S60	88	362/490,479.ccls. and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:26
S61	5	(US-20020167820-\$).did. or (US-6666571-\$ or US-6464381-\$ or US-6402354-\$ or US-6203180-\$).did.	US-PGPUB; USPAT	NEAR	ON	2009/05/18 12:52
S62	6	("5079675" "5520434" "6019411" "6331065").PN. OR ("6666571").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 12:54
S63	1	(US-7284886-\$).did.	USPAT	NEAR	ON	2009/05/18 12:57
S64	79	("3545110" "4104555" "4109235" "4138620" "4181925" "4297681" "4328532" "4365232" "4499451" "4561042" "4578617" "4580196" "4581683" "4647337" "4667273" "4754372" "4864473" "4951177" "4959759" "5013967" "5124845" "5142274" "5257167" "5272603" "5329429" "5339550" "5347434" "5414598" "5434013" "5434757" "5441339" "5479275" "5499170" "5504661" "5516143" "5549323" "5558364" "5564813" "5565733" "5566384" "5671996" "5803579" "5811930" "5917666" "5938321" "6008732" "6040534" "6082867" "6086131" "6087953" "6101032" "6111622" "6120159" "6124647" "6132072" "6139172" "6140934" "6144424" "6160475").PN. OR ("6464381"). URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 12:57
665	10	("5938321").PN. OR ("6402354").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:12
666	29	("4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:13
67	29	("4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:21
368	29	("4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:22
369	1	(US-7163305-\$).did.	USPAT	NEAR	ON	2009/05/18 13:22
370	29	("4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:23
 371	25	("3755663" "4104555" "4143297" "4159559" "4608308" "4631650" "4654765" "4661373" "4719405" "4994944" "5051654" "5144117").PN. OR ("5661374").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:24
372	2	(US-7163305-\$ or US-5661374-\$).did.	USPAT	NEAR	ON	2009/05/18 13:26

S73	7	(US-20050009242-\$).did. or (US-6893258-\$ or US-6743249-\$ or US-6595671-\$). did. or (JP-08202290-\$ or JP-06095064-\$).did. or (WO-9724770-\$).did.	US-PGPUB; USPAT; JPO; DERWENT	NEAR	ON	2009/05/18 13:27
S74	5	(US-6893258-\$ or US-6743249-\$ or US-6595671-\$).did. or (JP-08202290-\$ or JP-06095064-\$).did.	USPAT; JPO	NEAR	ON	2009/05/18 13:27
375	8	(US-20090099499-\$ or US-20090032825-\$ or US-20070030662-\$).did. or (US-20090032825-\$ or CN-200972986-\$ or KR-2007102320-\$ or CN-2934891-\$ or KR-2005100083-\$).did.	US-PGPUB; DERWENT	NEAR	ON	2009/05/18 13:27
376	13	S74 or S75	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ÖN	2009/05/18
377	6	.3\	US-PGPUB; USPAT	NEAR	ON	2009/05/18 13:27
S78	19		US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 13:27
379	21		US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/18 13:27
880	16	S69 or S72 or S63 or S79	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:27
881	3	(US-7284886-\$ or US-7163305-\$ or US-5661374-\$).did.	USPAT	NEAR	ON	2009/05/18 13:33
882	2	("6890089").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/05/18 13:33
S83	1	(US-6890089-\$).did.	USPAT	NEAR	ON	2009/05/18 13:34

S84	55	S81 or S82	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 13:35
S85	4	(US-7284886-\$ or US-7163305-\$ or US-5661374-\$ or US-6890089-\$).did.	USPAT	NEAR	ON	2009/05/18 13:35
S95	17185	((light emitting diode) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
S96	1063520	((light emitting diode) or "LED")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
S97	386	semiconductor light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
S98	22	(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
S99	1063613	S95 or S96 or S97 or S98	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34

S100	597412	(circuit board) or ((printed circuit board) or "PCB")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
S101	145	S100 and ((S99 with (laminat\$4 or embed\$3)) with (transparent or clear or (ligh transmit\$5) or refract\$4)) and (housing or case or casing)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
S102	65	S101 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:35
S103	12	("20020167820" "20020172039" "20050073851" "20050128760" "5101325" "6152569" "6240664" "6331065" "6666571" "6742907" "6890089" "7118239").PN. OR ("7284886").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 19:40
S104	29	("4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 19:58
S105	3	"6890089"	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 20:00
S106	2	"20080259623"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 09:40
S107	11	S106 and integrat\$3 and laminat\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 09:40
S108	1	S106 and integrat\$3 and laminat\$4 and (output element)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:11

S109	1	S106 and (output element)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:11
S111	17195	((light emitting diode) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:50
S112	1063914	((light emitting diode) or "LED")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:50
S113	386	semiconductor light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:50
S114		(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:50
S115	1064007	S111 or S112 or S113 or S114	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19
3116	77656	(laminat\$4 glass) or (layer\$4 glass)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:51

S117	689	(laminat\$4 glass panel) or (layer\$4 glass panel)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:52
S118	77656	S116 or S117	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:52
S119	6066	S115 and S118	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:52
S120	24	S115 with "in" with S118	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:53
S121	7	S115 with "within" with S118	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:53
S122	31	S120 or S121	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:54
S123	9	("20020024981" "20030025572" "20030087463" "4643532" "5376580" "6287882" "6292243" "6417478" "6861281").PN. OR ("7119375").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/19 11:28
S124	6	("2552955").URPN.	USPAT	NEAR	ON	2009/05/19 11:30

S125	0	day-stephen-\$.in	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 12:58
S126	37	day-stephen-\$.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 12:59
S127	0	"gb-0216787.2-"\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 13:03
S128	0	"GB-0216787"\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 13:04
S129	0	GB-0216787-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 13:04
S130	0	GB-02167872-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 13:04
S131	0	"02167872"	FPRS; EPO	NEAR	ON	2009/05/19 13:05
S132	27	DAY-STEPHEN.IN.	FPRS; EPO	NEAR	ON	2009/05/19 13:06
S133	12	("20010055458" "3317906" "4636698" "4761720" "4968895" "5193895" "5650208" "5890794" "6208031" "6270236" "6281525" "6361867").PN.	US-PGPUB; USPAT	NEAR	ON	2009/05/19 13:27

S134	32	("3317906").URPN.	USPAT	NEAR	ON	2009/05/19 13:30
S135	2	(("3317906") or ("6361867")).PN.	USPAT	OR	OFF	2009/05/19 14:27
S136	1	(US-6361867-\$).did.	USPAT	NEAR	ON	2009/05/19 14:29
S137	1	DE-4431890-\$.DID.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 14:30
S138	1	(GB-2281683-\$).did.	DERWENT	NEAR	ON	2009/05/19 14:31
S139	0	JP-2084684-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 14:33
S140	1	JP-02084684-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 14:33
S141	2	S137 or S138 or S140	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 14:37

5/19/2009 5:42:10 PM

C:\Documents and Settings\hsawhney\My Documents\EAST\Workspaces\10583957Light for the passanger compartment of a motor.wsp